CEL

GaAs HBT INTEGRATED CIRCUIT

μPG2314T5N

POWER AMPLIFIER FOR Bluetooth™ Class 1

DESCRIPTION

The μPG2314T5N is GaAs HBT MMIC for power amplifier which was developed for Bluetooth Class 1.

This device realizes high efficiency, high gain and high output power by using InGaP HBT. This device is housed in a 6-pin plastic TSON (Thin Small Out-line Non-leaded) package. And this package is able to high-density surface mounting.

FEATURES

- Operation frequency : f_{opt} = 2 400 to 2 500 MHz (2 450 MHz TYP.)
- Supply voltage : $V_{CC}1, 2$ = 2.7 to 3.6 V (3.0 V TYP.)
- Control voltage : V_{cont} = 0 to 3.6 V (3.0 V TYP.)
  : $V_{bias} + V_{enable}$ = 0 to 3.1 V (3.0 V TYP.)
- Circuit current : I_{CC} = 65 mA TYP. @ $V_{CC}1, 2$ = 3.0 V, $V_{bias} + V_{enable}$ = 3.0 V, V_{cont} = 3.0 V, P_{in} = 0 dBm
- Output power : P_{out} = +20 dBm TYP. @ $V_{CC}1, 2$ = 3.0 V, $V_{bias} + V_{enable}$ = 3.0 V, V_{cont} = 3.0 V, P_{in} = 0 dBm
- Gain control range : GCR = 23 dB TYP. @ $V_{CC}1, 2$ = 3.0 V, $V_{bias} + V_{enable}$ = 3.0 V, V_{cont} = 0 to 3.0 V, P_{in} = 0 dBm
- High efficiency : PAE = 50% TYP.
- High-density surface mounting : 6-pin plastic TSON package (1.5 × 1.5 × 0.37 mm)

APPLICATIONS

- Power Amplifier for Bluetooth Class 1

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2314T5N-E2	μPG2314T5N-E2-A	6-pin plastic TSON (Pb-Free)	G5D	• Embossed tape 8 mm wide • Pin 1, 6 face the perforation side of the tape • Qty 3 kpcs/reel

Remark To order evaluation samples, contact your nearby sales office.
Part number for sample order: μPG2314T5N

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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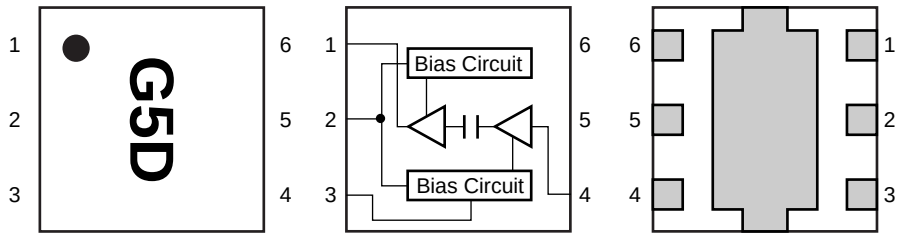
PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM

(Top View) (Top View) (Bottom View)



Pin No.	Pin Name
1	OUTPUT/V_{CC}2
2	V_{bias} + V_{enable}
3	V_{cont}
4	INPUT
5	V_{CC}1
6	GND

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V_{CC}1, 2	5.5	V
	V_{bias} + V_{enable}	3.6	V
Control Voltage	V_{cont}	3.6	V
Circuit Current	I_{CC}	400	mA
Control Current	I_{cont}	0.5	mA
Input Power	P_{in}	+10	dBm
Power Dissipation	P_D	700 Note	mW
Operating Ambient Temperature	T_A	−40 to +85	°C
Storage Temperature	T_{stg}	−55 to +150	°C

Note Mounted on double-sided copper-clad 50 × 50 × 1.6 mm epoxy glass PWB, T_A = +85°C

RECOMMENDED OPERATING RANGE (T_A = +25°C, unless otherwise specified)

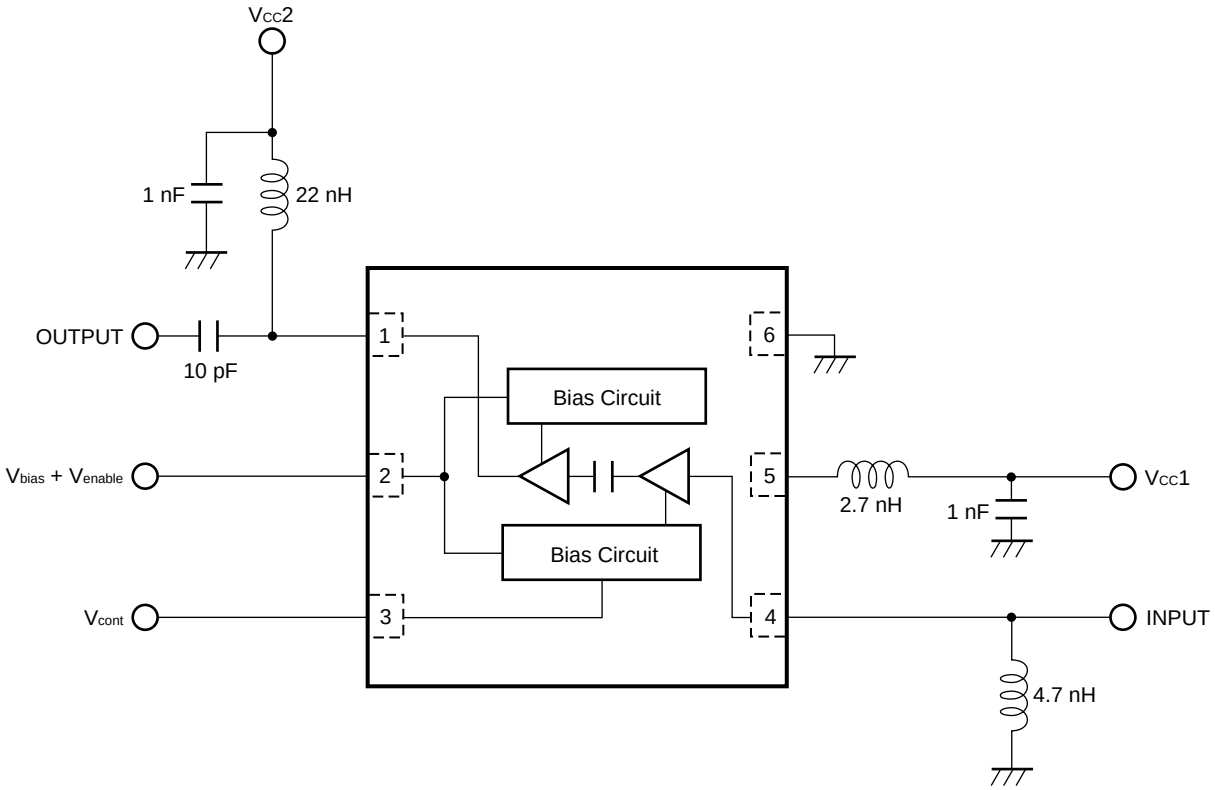
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f_{opt}	2 400	2 450	2 500	MHz
Supply Voltage	V_{CC}1, 2	2.7	3.0	3.6	V
	V_{bias} + V_{enable}	0	3.0	3.1	V
Control Voltage	V_{cont}	0	3.0	3.6	V

ELECTRICAL CHARACTERISTICS

(T_A = +25°C, V_{CC}1, 2 = V_{bias} + V_{enable} = 3.0 V, f = 2 450 MHz, P_{out} = +20 dBm, External input and output matching, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	I_{CC}	V_{cont} = 3.0 V, P_{in} = 0 dBm	–	65	70	mA
Shut Down Current	$I_{shut\ down}$	V_{cont} = 3.0 V, P_{in} = 0 dBm , V_{bias} + V_{enable} = 0 V	–	0	1	μA
Output Power 1	P_{out}1	V_{cont} = 3.0 V, P_{in} = 0 dBm	+18.0	+20.0	–	dBm
Output Power 2	P_{out}2	V_{cont} = 0 V, P_{in} = 0 dBm	–	–3.0	+1.0	dBm
Gain Control Range	GCR	V_{cont} = 0 to 3.0 V, P_{in} = 0 dBm	17	23	–	dB
Efficiency	PAE	V_{cont} = 3.0 V, P_{in} = 0 dBm	–	50	–	%

EVALUATION CIRCUIT

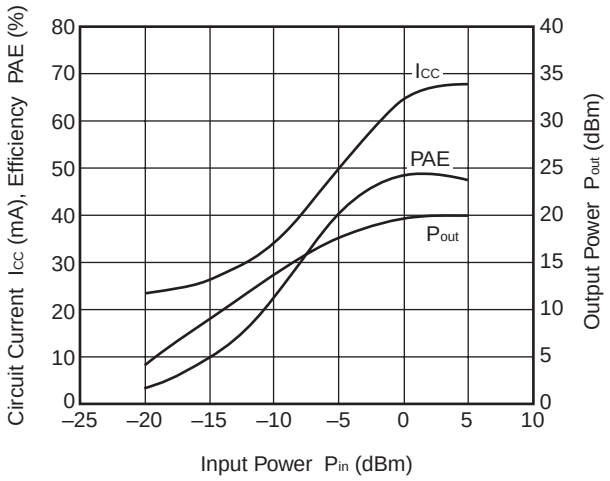


The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

TYPICAL CHARACTERISTICS (T_A = +25°C, unless otherwise specified)

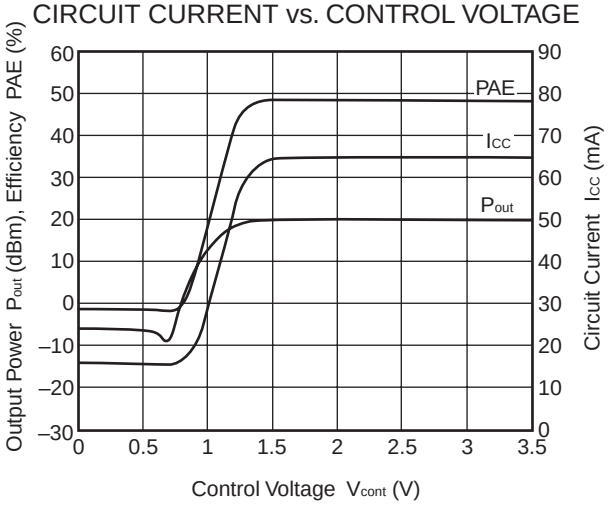
Condition : f = 2 450 MHz, $V_{CC}1 = V_{CC}2 = V_{bias} + V_{enable} = V_{cont}$ = 3.0 V, with external input and output matching circuit

CIRCUIT CURRENT, EFFICIENCY, OUTPUT POWER vs. INPUT POWER



Condition : f = 2 450 MHz, $V_{CC}1 = V_{CC}2 = V_{bias} + V_{enable}$ = 3.0 V, P_{in} = 0 dBm, with external input and output matching circuit

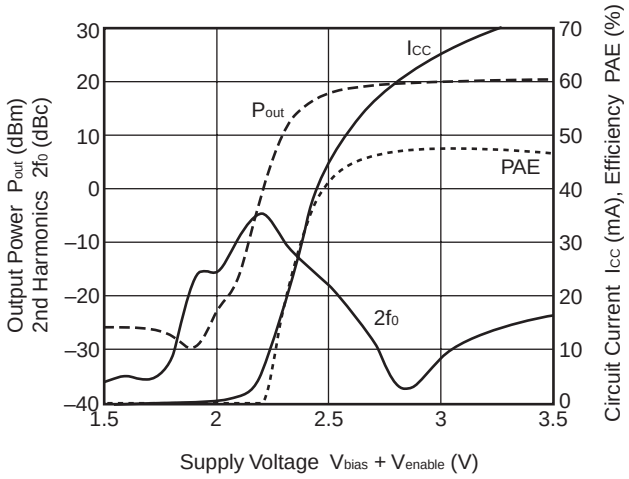
OUTPUT POWER, EFFICIENCY, CIRCUIT CURRENT vs. CONTROL VOLTAGE



Remark The graphs indicate nominal characteristics.

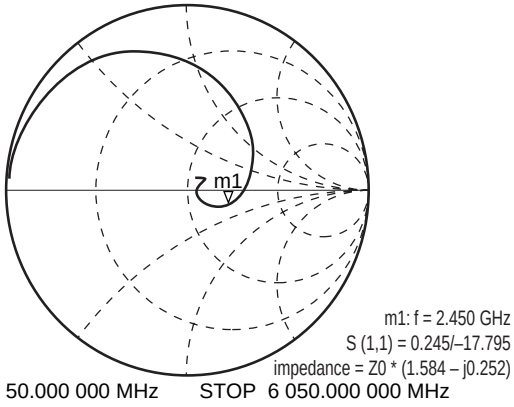
Condition : f = 2 450 MHz, $V_{CC}1 = V_{CC}2 = V_{cont}$ = 3.0 V, P_{in} = 0 dBm, with external input and output matching circuit

OUTPUT POWER, 2f_0, CIRCUIT CURRENT, EFFICIENCY vs. SUPPLY VOLTAGE

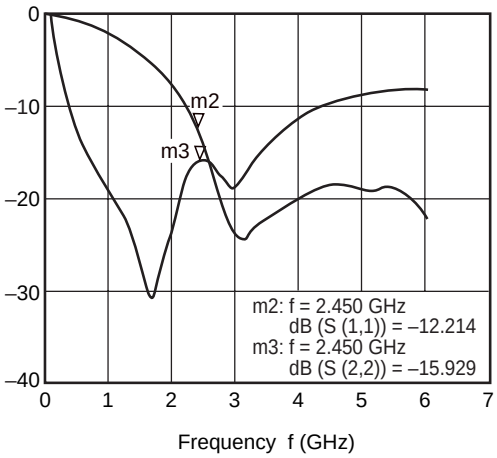


Condition : $V_{CC}1 = V_{CC}2 = V_{bias} + V_{enable} = V_{cont}$ = 3.0 V, P_{in} = –20 dBm, with external input and output matching circuit

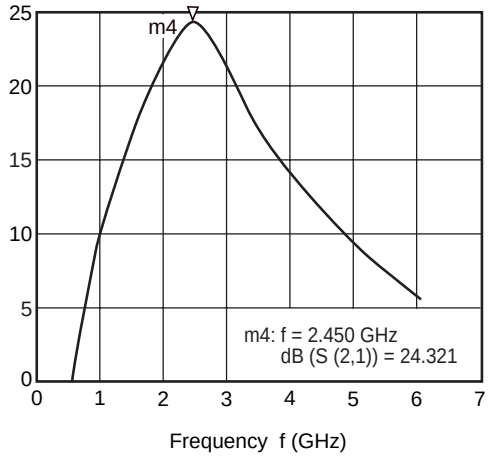
S11-FREQUENCY



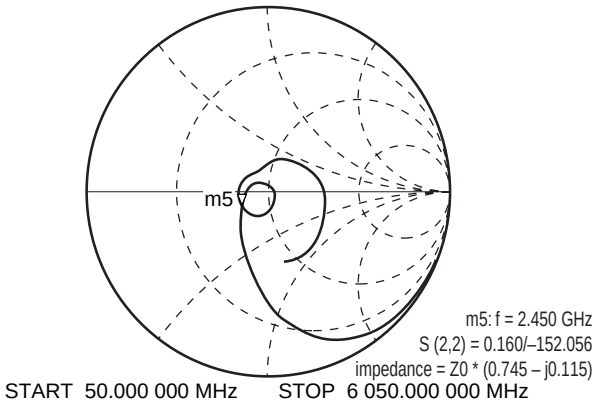
S11, S22-FREQUENCY



S21-FREQUENCY



S22-FREQUENCY

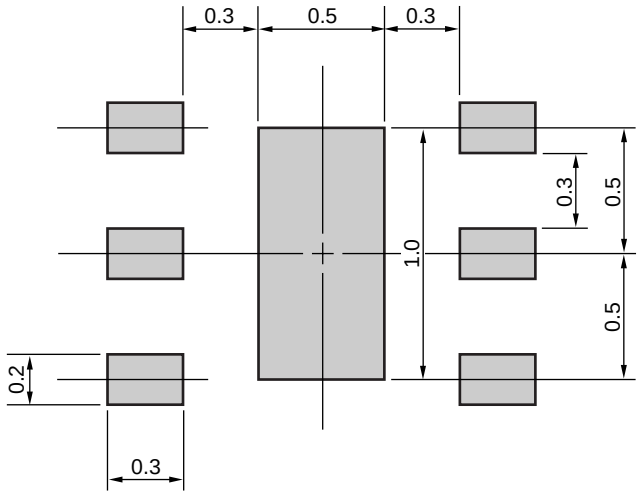


Remark The graphs indicate nominal characteristics.

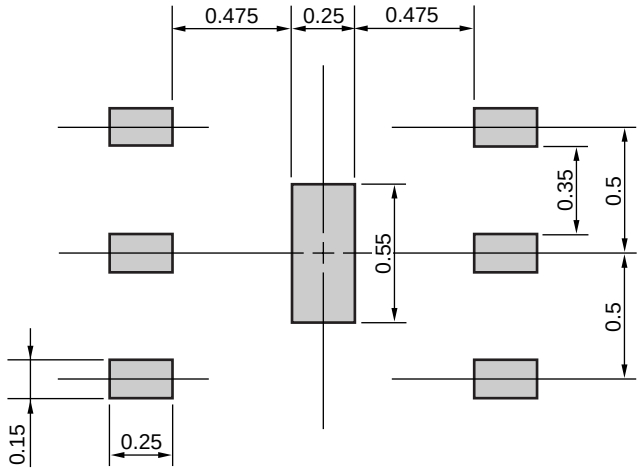
MOUNTING PAD AND SOLDER MASK LAYOUT DIMENSIONS

6-PIN PLASTIC TSON (UNIT: mm)

MOUNTING PAD



SOLDER PAD

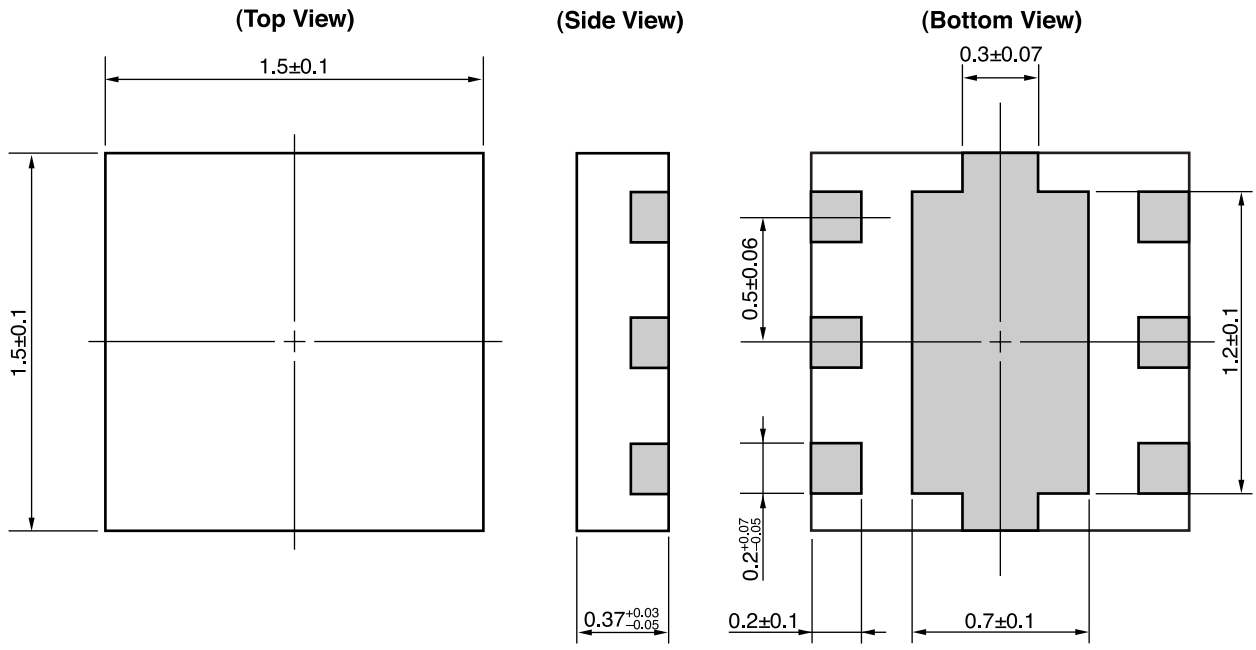


Solder thickness : 0.08 mm

Remark The mounting pad layouts in this document are for reference only.

PACKAGE DIMENSIONS

6-PIN PLASTIC TSON (UNIT: mm)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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M8E 02. 11-1

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points. • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth.

▶**For further information, please contact**

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CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices	
Lead (Pb)	< 1000 PPM	-A	-AZ
		Not Detected	(*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

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